



Three-terminal positive voltage regulator

LM78L05A



SOT-89 Plastic Package RoHS compliant

SOT-89

FEATURE:

- 1. Internal thermal overload protection.
- 2. Internal short circuit current limit.
- 3. This product is available in AEC-Q101 Compliant and PPAP Capable also.

Note: For AEC-Q101 compliant products, please use suffix -AQ in the part number while ordering.

PARAMETER	SYMBOL	VALUE	UNIT
Maximum Output current	I _{OM}	0.1	Α
Output voltage	Vo	5	V
Continuous total dissipation (T _a = 25°C)	P_{D}	0.8	W

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	VALUE	UNIT				
Input Voltage	V_1	30	V				
Operating Junction Temperature Range	T _{OPR}	0 to +150	°C				
Storage Temperature Range	T _{STG}	-55 to +150	°C				

ELECTRICAL CHARACTERISTICS at (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIO	TEST CONDITION			MAX	UNIT
		7V≤ V _i ≤20V,	25°C	4.8	5.0	5.2	V
Output Voltage	V _o	I _O =1mA - 40mA	0-125°C	4.75	5.0	5.25	V
		I _O =1mA - 70mA	0-125 C	4.75	5.0	5.25	V
Load Regulation	۸۱/	I _O =1mA - 100mA	25°C	ŀ	15	60	mV
Load Regulation	ΔV_{o}	I _O =1mA - 40mA	25°C		8	30	mV
Line Regulation	۸۱/	7V≤ Vi ≤20V	25°C	-	32	150	mV
Line Regulation	ΔV_{o}	8V≤ Vi ≤20V	25°C	-	26	100	mV
Quiescent Current	Ι _α		25°C	-	3.8	6	mA
0	4.1	8V≤ Vi ≤20V	0-125°C	-		1.5	mA
Quiescent Current Change	ΔI_q	1mA≤l _O ≤40mA	0-125°C	ŀ	-	0.1	mA
Output Noise Voltage	V_N	f =10Hz to 100KHz	25°C	ŀ	42	-	μV
Ripple Rejection	RR	f =120Hz, 8V≤ Vi ≤20V	0-125°C	41	19		dB
Dropout Voltage	Vd		25°C		1.7		V





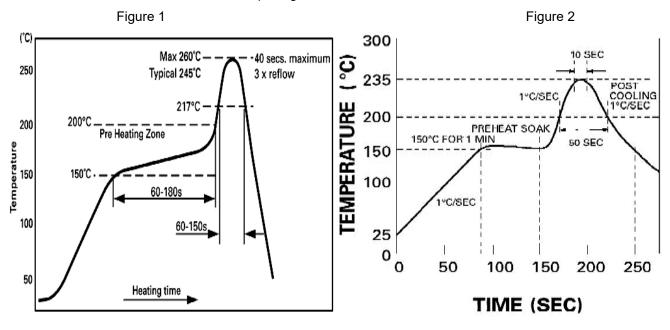


Recommended Reflow Solder Profiles

The recommended reflow solder profiles for Pb and Pb-free devices are shown below.

Figure 1 shows the recommended solder profile for devices that have Pb-free terminal plating, and where a Pb-free solder is used.

Figure 2 shows the recommended solder profile for devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with a leaded solder.



Reflow profiles in tabular form

Profile Feature	Sn-Pb System	Pb-Free System	
Average Ramp-Up Rate	~3°C/second	~3°C/second	
Preheat			
 Temperature Range 	150-170°C	150-200°C	
– Time	60-180 seconds	60-180 seconds	
Time maintained above:			
Temperature	200°C	217°C	
– Tim	30-50 seconds	60-150 seconds	
Peak Temperature	235°C	260°C max.	
Time within +0 -5°C of actual Peak	10 seconds	40 seconds	
Ramp-Down Rate	3°C/second max.	6°C/second max	



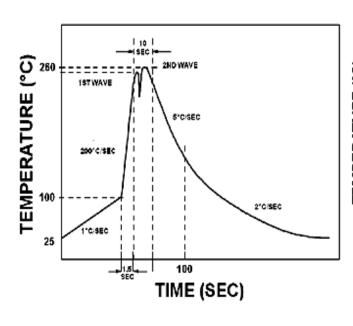


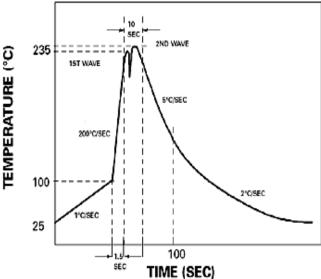


Recommended Wave Solder Profiles

The Recommended solder Profile For Devices with Pb-free terminal plating where a Pb-free solder is used

The Recommended solder Profile For Devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with leaded solder





Wave Profiles in Tabular Form

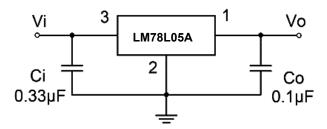
Profile Feature	Sn-Pb System	Pb-free System
Average Ramp-Up Rate	~200°C/second	~200°C/second
Heating rate during preheat	Typical 1-2, Max 4°C/sec	Typical 1-2, Max 4°C/Sec
Final preheat Temperature	Within 125°C of Solder Temp	Within 125°C of Solder Temp
Peak Temperature	235°C	260°C max.
Time within +0 -5°C of actual Peak	10 seconds	10 seconds
Ramp-Down Rate	5°C/second max.	5°C/second max.







Typical Application



Note:

Bypass capacitors are recommended for optimum stability and transient response and should be located as close as Possible to the regulators.







TYPICAL CHARACTERISTIC CURVES

Fig 2: Quiescent Current vs Input Voltage

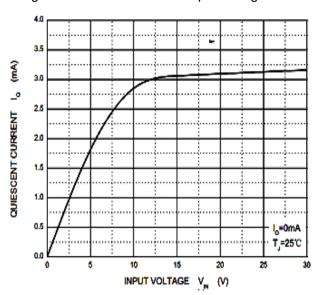


Fig 3: Dropout Characteristics

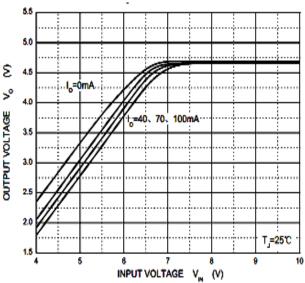
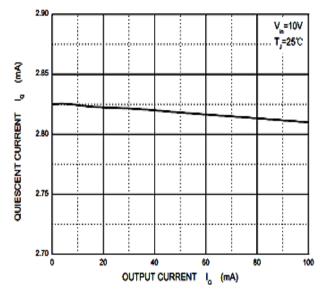


Fig 4: Quiescent Current vs Output Current





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TYPICAL CHARACTERISTIC CURVES

Fig 5: Output Voltage vs Ambient Temp

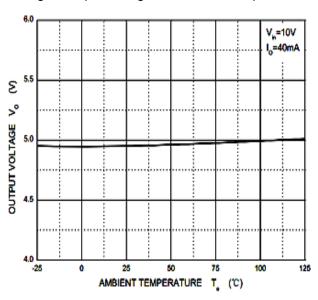


Fig 6: Power Derating Curve

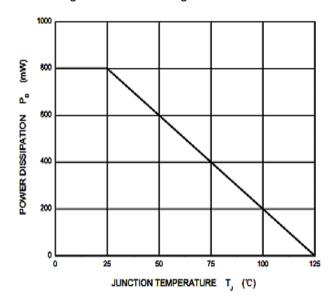
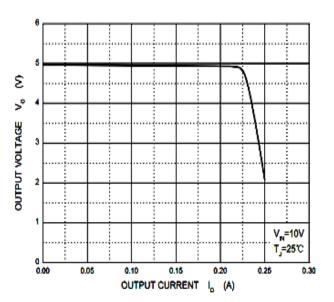


Fig 7: Current Cut-off Grid Voltage



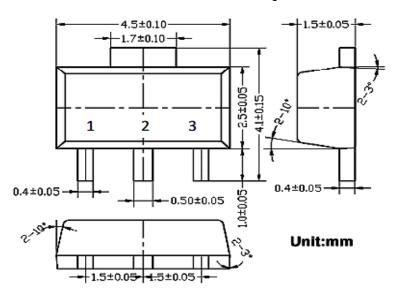






Package Details

SOT-89 Plastic Package



Pin Configuration

- 1. OUT
- 2. GND
- 3. IN



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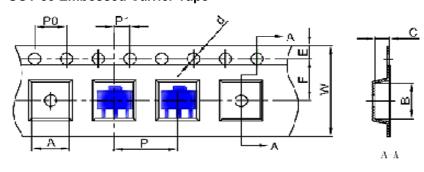






SOT-89 Tape and Reel

SOT-89 Embossed Carrier Tape

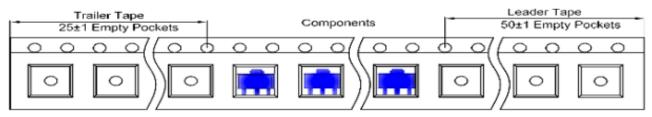


Packaging Description:

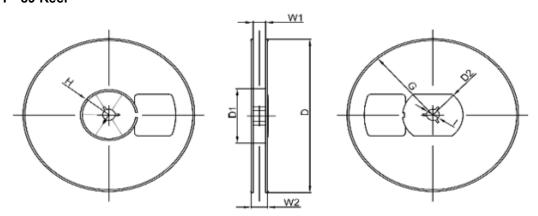
SOT-89 Parts are shipped in tape. The carrier tape is made from a disposable (carbon filled) polycarbonate resin. The cover tape is a multiplayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-Static sprayed agent. these reeled parts in standard option are shipped with 3000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	Pkg type A B C d E F P0 P P1 W									
SOT-89-3L	4.85	4.45	1.80	Ø1.50	1./5	5.50	4.00	8.00	2.00	12.00

SOT-89 Tape Leader and Trailer



SOT - 89 Reel



Dimensions are in millimeter								
Reel Option D D1 D2 G H I W1 W2								
7"Dia	Ø180.00	60.00	R32.00	R86.50	R30.00	Ø13.00	13.20	16.50

KEEL	Reel Size	ROX	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
1000 pcs	7 inch	10,000 pcs	203×203×195	40,000 pcs	438×438×220	

LM78L05A

Rev1 21022023EJS







Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- · Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- · Air should be clean.
- · Avoid harmful gas or dust.
- · Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- · Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- · Avoid condensation.
- · Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- \cdot The product shall be stored on a plane area. They should not be turned upside down.

They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level					
Level	Time	Condition			
1	Unlimited	≤30 °C / 85% RH			
2	1 Year	≤30 °C / 60% RH			
2a	4 Weeks	≤30 °C / 60% RH			
3	168 Hours	≤30 °C / 60% RH			
4	72 Hours	≤30 °C / 60% RH			
5	48 Hours	≤30 °C / 60% RH			
5a	24 Hours	≤30 °C / 60% RH			
6	Time on Label(TOL)	≤30 °C / 60% RH			







Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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